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**ON Semiconductor®** 

# FDD86580-F085

## N-Channel PowerTrench<sup>®</sup> MOSFET **60 V, 50 A, 10 m**Ω

#### **Features**

- Typical  $R_{DS(on)}$  = 7.8 mΩ at  $V_{GS}$  = 10V,  $I_D$  = 50 A
- Typical Q<sub>g(tot)</sub> = 20 nC at V<sub>GS</sub> = 10V, I<sub>D</sub> = 50 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

#### Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Starter/Alternator
- Distributed Power Architectures and VRM

#### Primary Switch for 12V Systems

#### **MOSFET Maximum Ratings** T<sub>J</sub> = 25°C unless otherwise noted.

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-to-Source Voltage		60	V
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V
	Drain Current - Continuous (V <sub>GS</sub> =10) (Note 1)	T <sub>C</sub> =25°C	50	•
D	Pulsed Drain Current	T <sub>C</sub> = 25°C	See Figure 4	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	24	mJ
D	Power Dissipation		75	W
P <sub>D</sub>	Derate Above 25°C		0.5	W/ <sup>o</sup> C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to + 175	°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case		2.0	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	52	°C/W

Notes:

- 1: Current is limited by bondwire configuration.

ROHS

G

S

2: Starting T<sub>J</sub> = 25°C, L = 30µH, I<sub>AS</sub> = 40A, V<sub>DD</sub> = 60V during inductor charging and V<sub>DD</sub> = 0V during time in avalanche. 3:  $R_{0JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0JC</sub> is guaranteed by design, while R<sub>0JA</sub> is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

### Package Marking and Ordering Information

<b>Device Marking</b>	Device	Package	Reel Size	Tape Width	Quantity
FDD86580	FDD86580-F085	D-PAK(TO-252)	13"	16mm	2500units

FDD86580-F085 N-Channel PowerTrench<sup>®</sup> MOSFET

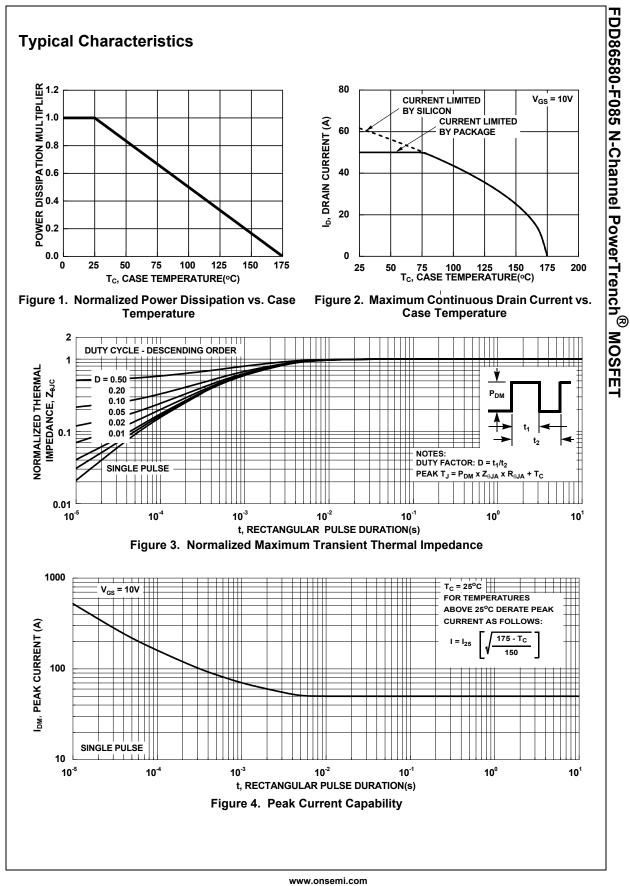
D

D-PAK

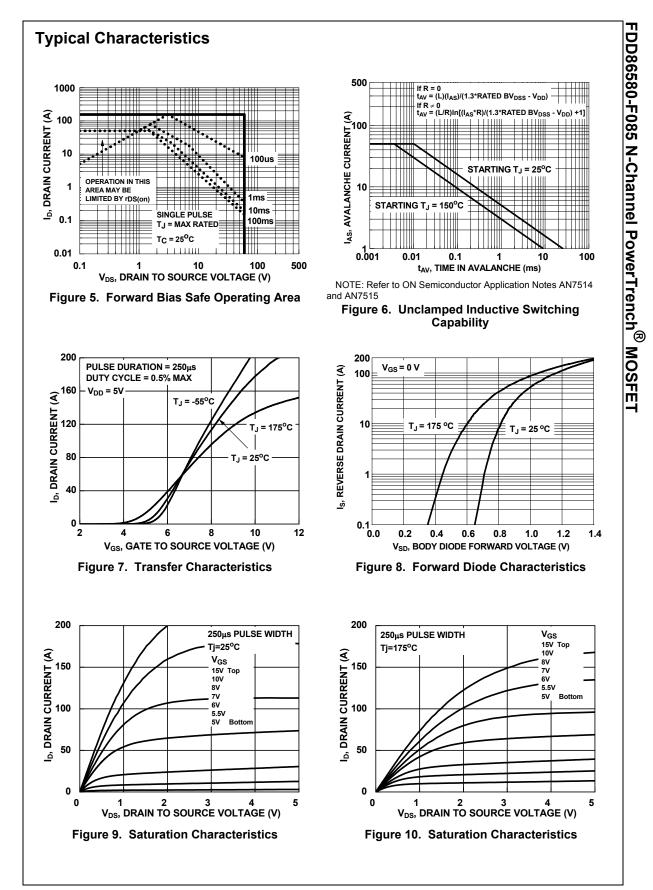
(TO-252)

	Parameter	Test Conditions		Min.	Тур.	Max.	Units
Off Cha	racteristics						
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	I <sub>D</sub> = 250μA,	V <sub>GS</sub> = 0V	60	-	-	V
	V <sub>DS</sub> =6		$T_{\rm J} = 25^{\circ} C$		-	1	μA
IDSS	Drain-to-Source Leakage Current	$V_{GS} = 0V$	$T_{\rm J} = 175^{\rm o}C$ (Note 4)	-	-	1	mA
I <sub>GSS</sub>	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250µA		2.0	3.6	4.2	V
		$I_{\rm D} = 50$ A, $T_{\rm J} = 25^{\circ}$ C		-	7.8	10	mΩ
R <sub>DS(on)</sub>	Drain to Source On Resistance		$T_{.1} = 175^{\circ}C$ (Note 4)	-	15.2	19	mΩ
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V, f = 1MHz		-	1430	-	pF
C <sub>oss</sub>	Output Capacitance			-	440	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			-	25	-	pF
R <sub>g</sub>	Gate Resistance	V <sub>GS</sub> = 0.5V, f = 1MHz		-	1.8	-	Ω
Q <sub>g(ToT)</sub>	Total Gate Charge	$V_{GS} = 0$ to 10V $V_{DD} = 30V$		-	20	30	nC
Q <sub>g(th)</sub>	Threshold Gate Charge	$V_{GS}$ = 0 to 2	V I <sub>D</sub> = 50A	-	3	-	nC
Q <sub>gs</sub>	Gate-to-Source Gate Charge		_	-	9	-	nC
Q <sub>gd</sub>	Gate-to-Drain "Miller" Charge			-	4	-	nC
Switchi	ng Characteristics						
t <sub>on</sub>	Turn-On Time			-	-	34	ns
t <sub>d(on)</sub>	Turn-On Delay			-	12	-	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 30V,	I <sub>D</sub> = 50A,	-	11	-	ns
t <sub>d(off)</sub>	Turn-Off Delay	$V_{GS}$ = 10V, $R_{GEN}$ = 6 $\Omega$		-	15	-	ns
t <sub>f</sub>	Fall Time			-	5	-	ns
t <sub>off</sub>	Turn-Off Time			-	-	30	ns
	ource Diode Characteristics						
Drain-S		I <sub>SD</sub> = 50A, V		-	-	1.25	V
	Source-to-Drain Diode Voltage	I <sub>SD</sub> = 25A, V <sub>GS</sub> = 0V		-	-	1.2	V
V <sub>SD</sub>	Source-to-Drain Diode Voltage	-					
	Source-to-Drain Diode Voltage Reverse-Recovery Time Reverse-Recovery Charge	$I_{SD} = 25A, V_{DD} = 48V, dI_{SD}/dt = 100$	I <sub>F</sub> = 50A,	-	41 30	61 45	ns nC

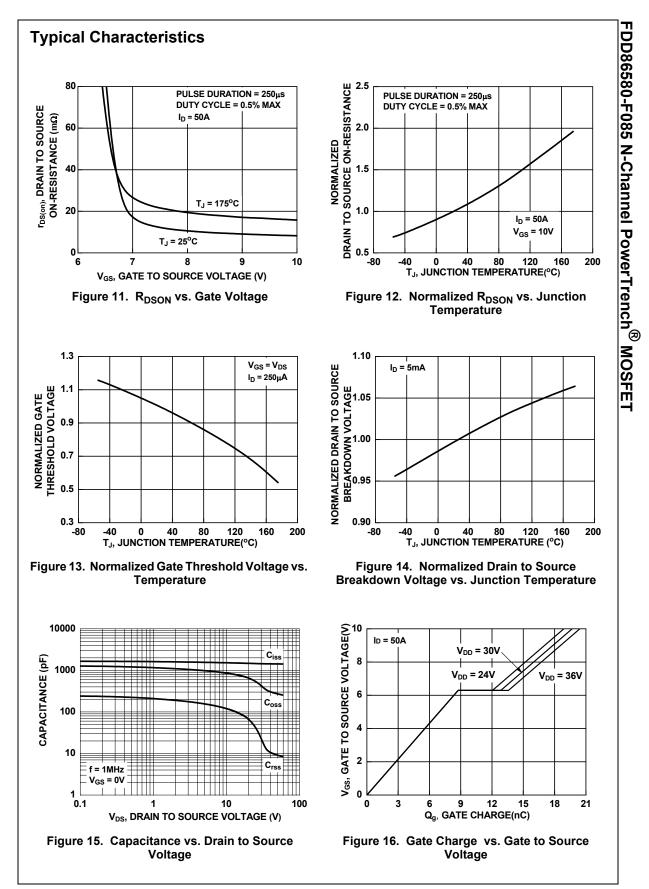
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